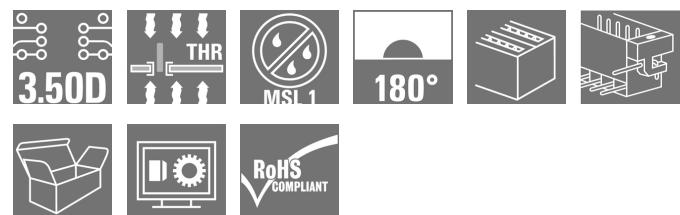


**S2C-SMT 3.50/04/180LF 3.5SN BK BX**

**Weidmüller Interface GmbH & Co. KG**  
 Klingenbergsstraße 26  
 D-32758 Detmold  
 Germany

[www.weidmueller.com](http://www.weidmueller.com)

**Product image**

Similar to illustration

**High-temperature-resistant pin header.**

- touch-safe
- can be plugged into B2CF 3.50 PUSH IN female plug
- Plug-in direction is perpendicular or parallel to the circuit board (180° / 90°)
- Housing variants: closed (G) and with solder flange (LF)
- Box packaging (BX) or, anti-static, tape-on-reel (RL)
- Suitable for reflow and wave soldering applications
- Pin length of either 1.5 mm or 3.5 mm

**General ordering data**

Version	PCB plug-in connector, male header, Solder flange, THT/THR solder connection, 3.50 mm, Number of poles: 4, 180°, Solder pin length (l): 3.5 mm, tinned, black, Box
Order No.	<a href="#">1290220000</a>
Type	S2C-SMT 3.50/04/180LF 3.5SN BK BX
GTIN (EAN)	4050118083231
Qty.	132 pc(s).
Product data	IEC: 200 V / 13.4 A UL: 150 V / 10 A
Packaging	Box

Creation date September 16, 2022 3:05:18 AM CEST

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**Technical data****Dimensions and weights**

Depth	10.8 mm	Depth (inches)	0.425 inch
Height	17.7 mm	Height (inches)	0.697 inch
Height of lowest version	14.2 mm	Width	14 mm
Width (inches)	0.551 inch	Net weight	2.24 g

**System specifications**

Product family	OMNIMATE Signal - series B2C/S2C 3.50 - 2-row	Type of connection	Board connection
Mounting onto the PCB	THT/THR solder connection	Pitch in mm (P)	3.5 mm
Pitch in inches (P)	0.138 inch	Outgoing elbow	180°
Number of poles	4	Number of solder pins per pole	1
Solder pin length (l)	3.5 mm	Solder pin length tolerance	0 / -0.3 mm
Solder pin dimensions	d = 1.0 mm, Octagonal	Solder pin dimensions = d tolerance	+0,01 / -0,03 mm
Solder eyelet hole diameter (D)	1.3 mm	Solder eyelet hole diameter tolerance (D)+ 0,1 mm	
Outside diameter of solder pad	2.1 mm	Template aperture diameter	1.9 mm
L1 in mm	3.5 mm	L1 in inches	0.138 inch
Number of rows	1	Pin series quantity	2
Touch-safe protection acc. to DIN VDE 57 106	Safe from finger touch	Touch-safe protection acc. to DIN VDE 0470	IP 20
Can be coded	Yes	Plugging force/pole, max.	3.5 N
Pulling force/pole, max.	2.5 N		

**Material data**

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	IIIb
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	Copper alloy
Contact surface	tinned	Layer structure of solder connection	1...3 µm Ni / 2...4 µm Sn matt
Layer structure of plug contact	1...3 µm Ni / 2...4 µm Sn matt	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	120 °C	Temperature range, installation, min.	-40 °C
Temperature range, installation, max.	120 °C		

**Rated data acc. to IEC**

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	13.4 A
Rated current, min. number of poles (Tu=40°C)	12 A	Rated voltage for surge voltage class / pollution degree II/2	200 V
Rated voltage for surge voltage class / pollution degree III/2	160 V	Rated voltage for surge voltage class / pollution degree III/3	80 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	2.5 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	2.5 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	2.5 kV	Short-time withstand current resistance	3 x 1s with 80 A

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**Technical data****Rated data acc. to CSA**

Institute (CSA)



Certificate No. (CSA)

200039-1121690

Rated voltage (Use group B / CSA)	150 V
Rated voltage (Use group D / CSA)	150 V
Rated current (Use group C / CSA)	9.5 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.

Rated voltage (Use group C / CSA)	50 V
Rated current (Use group B / CSA)	9.5 A
Rated current (Use group D / CSA)	9.5 A

**Packing**

Packaging	Box	VPE length	340 mm
VPE width	134 mm	VPE height	21 mm

**Classifications**

ETIM 6.0	EC002637	ETIM 7.0	EC002637
ETIM 8.0	EC002637	ECLASS 9.0	27-44-04-02
ECLASS 9.1	27-44-04-02	ECLASS 10.0	27-44-04-02
ECLASS 11.0	27-46-02-01	ECLASS 12.0	27-46-02-01

**Important note**

IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.
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Notes	<ul style="list-style-type: none"> <li>• Gold-plated contact surfaces on request</li> <li>• Rated current related to rated cross-section &amp; min. No. of poles.</li> <li>• Spacing between rows: see hole layout</li> <li>• P on drawing = pitch</li> <li>• Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.</li> <li>• Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months</li> </ul>
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**Approvals**

Approvals



ROHS	Conform
UL File Number Search	UL Website
Certificate No. (cURus)	E60693

**S2C-SMT 3.50/04/180LF 3.5SN BK BX**

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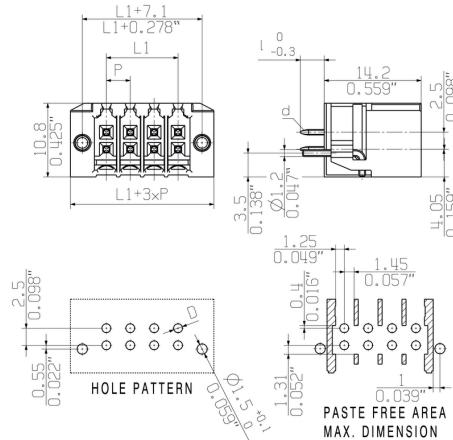
**Technical data****Downloads**

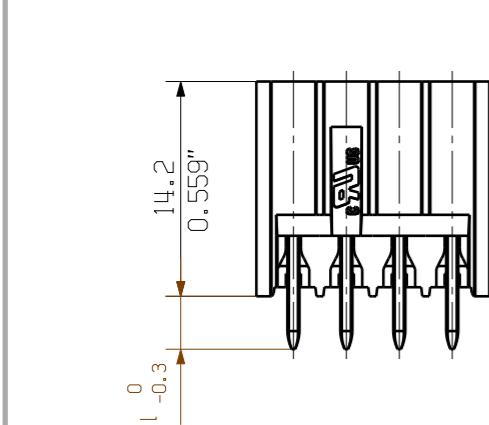
Approval/Certificate/Document of Conformity	<a href="#">Declaration of the Manufacturer</a>
Engineering Data	<a href="#">CAD data – STEP</a>
Engineering Data	<a href="#">EPLAN, WSCAD</a>
Catalogues	<a href="#">Catalogues in PDF-format</a>
Brochures	<a href="#">FL DRIVES EN</a> <a href="#">MB SMT EN</a> <a href="#">FL DRIVES DE</a> <a href="#">MB DEVICE MANUF. EN</a> <a href="#">FL BUILDING SAFETY EN</a> <a href="#">FL APPL LED LIGHTING EN</a> <a href="#">FL INDUSTR.CONTROLS EN</a> <a href="#">FL MACHINE SAFETY EN</a> <a href="#">FL HEATING ELECTR EN</a> <a href="#">FL APPL_INVERTER EN</a> <a href="#">FL_BASE_STATION EN</a> <a href="#">FL_ELEVATOR EN</a> <a href="#">FL_POWER_SUPPLY EN</a> <a href="#">FL 72H SAMPLE SER EN</a> <a href="#">PO OMNIMATE EN</a> <a href="#">PO OMNIMATE EN</a>
White paper surface mount technology	<a href="#">Download Whitepaper</a>

**S2C-SMT 3.50/04/180LF 3.5SN BK BX**

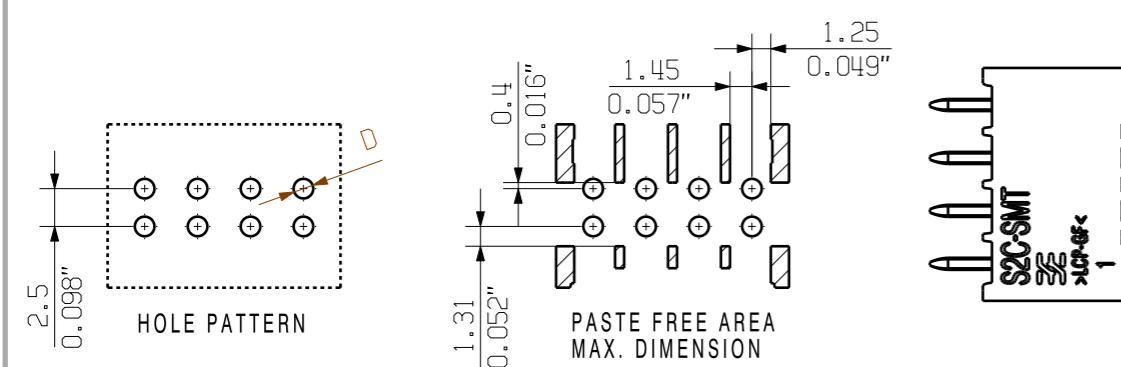
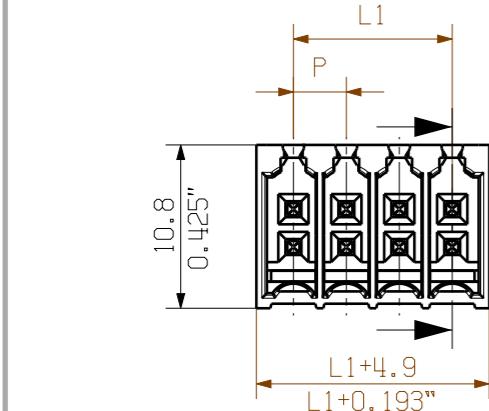
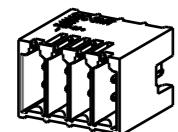
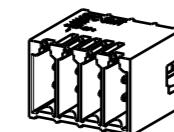
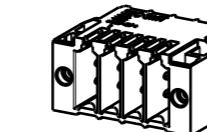
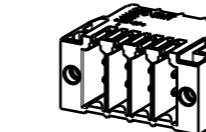
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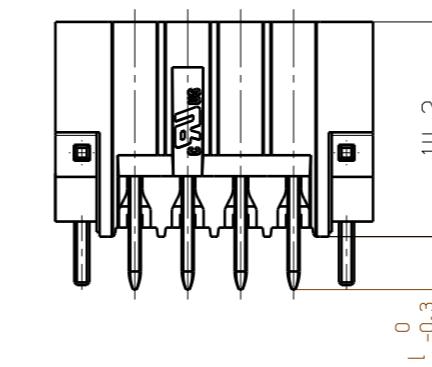
**Drawings****Dimensional drawing**



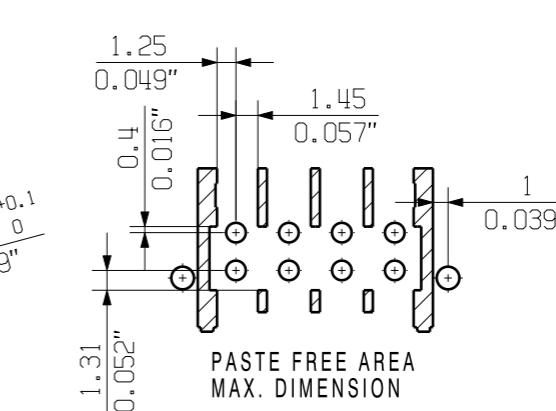
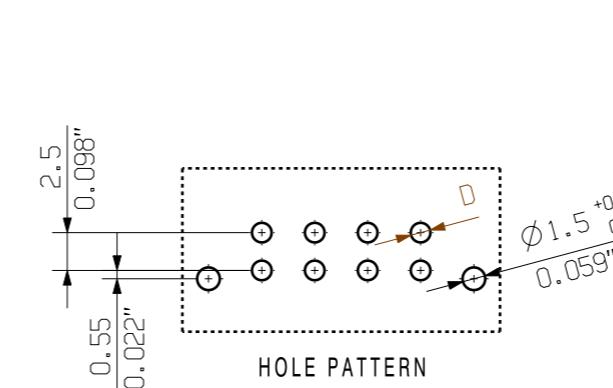
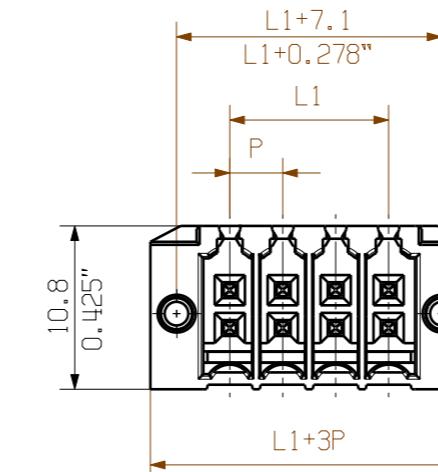
SHOWN: S2C-SMT 3.50/08/180G 3.5

M 1/1  
S2C-SMT 3.50/08/180G 1.5M 1/1  
S2C-SMT 3.50/08/180G 3.5M 1/1  
S2C-SMT 3.50/08/180LF 1.5M 1/1  
S2C-SMT 3.50/08/180LF 3.5

allgemeingültige Kundenzeichnung, aktueller Stand nur auf Anfrage  
general customer drawing, topical version only if required



SHOWN: S2C-SMT 3.50/08/180LF 3.5



P = 3.50 RASTER  
PITCH

D\* = 01.3 +0.1  
0.051"

d = 0.8x0.8  
0.031" x 0.031"

\* from n (no of poles) 26  
D = 1.4mm +0.1

S2C-SMT 3.50...180LF 3.5	3.5	0.138
S2C-SMT 3.50...180LF 1.5	1.5	0.059
S2C-SMT 3.50...180G 3.5	3.5	0.138
S2C-SMT 3.50...180G 1.5	1.5	0.059
TYP	1	1
PART NAME	[mm]	[inch]

For the mounting of PCBs, it should be noted that the rated data relates only to the PCB components alone.

The necessary creepage and clearance paths must be observed in connection with the respective applicant in accordance to IEC 664 / VDE 0110.

The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine.

Weidmüller PCB components are tested to the DIN EN 61984 standard, and are valid for its field of application. Provided that the components are used to the intended purpose, all requirements with respect to the occurring of electrical, mechanical, thermic and corrosive stress will be satisfied.

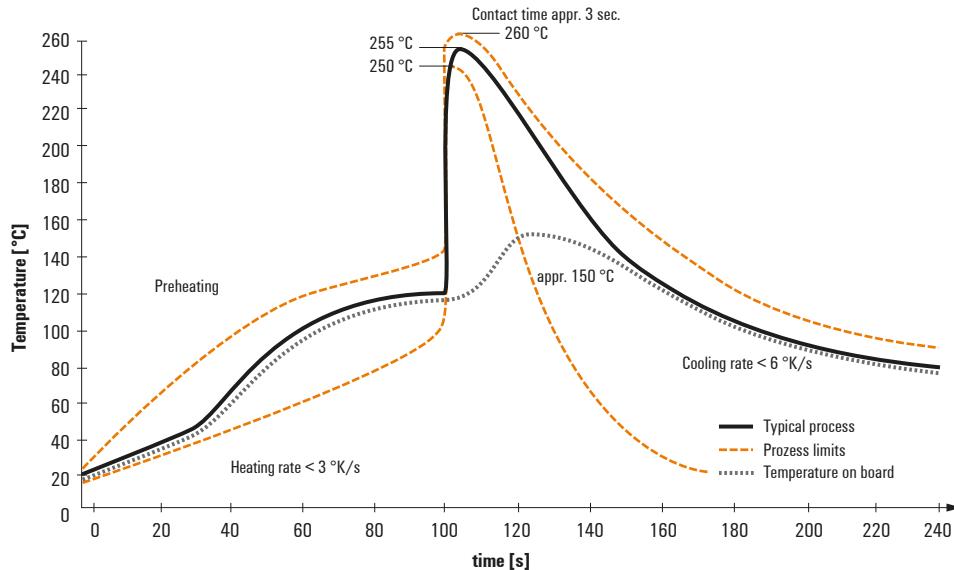
36	59.5	2.343	±0.2
34	56.0	2.205	
32	52.5	2.067	
30	49.0	1.929	
28	45.5	1.791	
26	42.0	1.654	
24	38.5	1.516	
22	35.0	1.378	
20	31.5	1.240	
18	28.0	1.102	
16	24.5	0.965	
16	24.5	0.965	
14	21.0	0.827	
12	17.5	0.689	
10	14.0	0.551	
8	10.5	0.413	
6	7.00	0.276	
4	3.50	0.138	
n POLZAHL		L1	TOLERANZ
n POLES		L1	
		[mm]	[inch]

GENERAL TOLERANCE: DIN ISO 2768-m			Modification	Cat. no.: 3 50160 06		
Max. nos. ✓				99681/4 22.03.18 AMANN_A 01	Drawn	Date
Scale: 2/1	Checked	04.04.2018	Name	AMANN_A	15.07.2011	FRIELING_L
Supersedes: .	Approved	. . .	. . .	. . .	. . .	. . .
Product file: B2CF/S2C	. . .	. . .	. . .	. . .	. . .	. . .

S2C-SMT 3.50/.../  
STIFTLEISTE  
MALE HEADER

## Recommended wave soldering profiles

**Weidmüller Interface GmbH & Co. KG**  
 Klingenbergsstraße 16  
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 Germany  
 Fon: +49 5231 14-0  
 Fax: +49 5231 14-292083  
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**Single Wave:****Double Wave:****Wave soldering profiles**

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

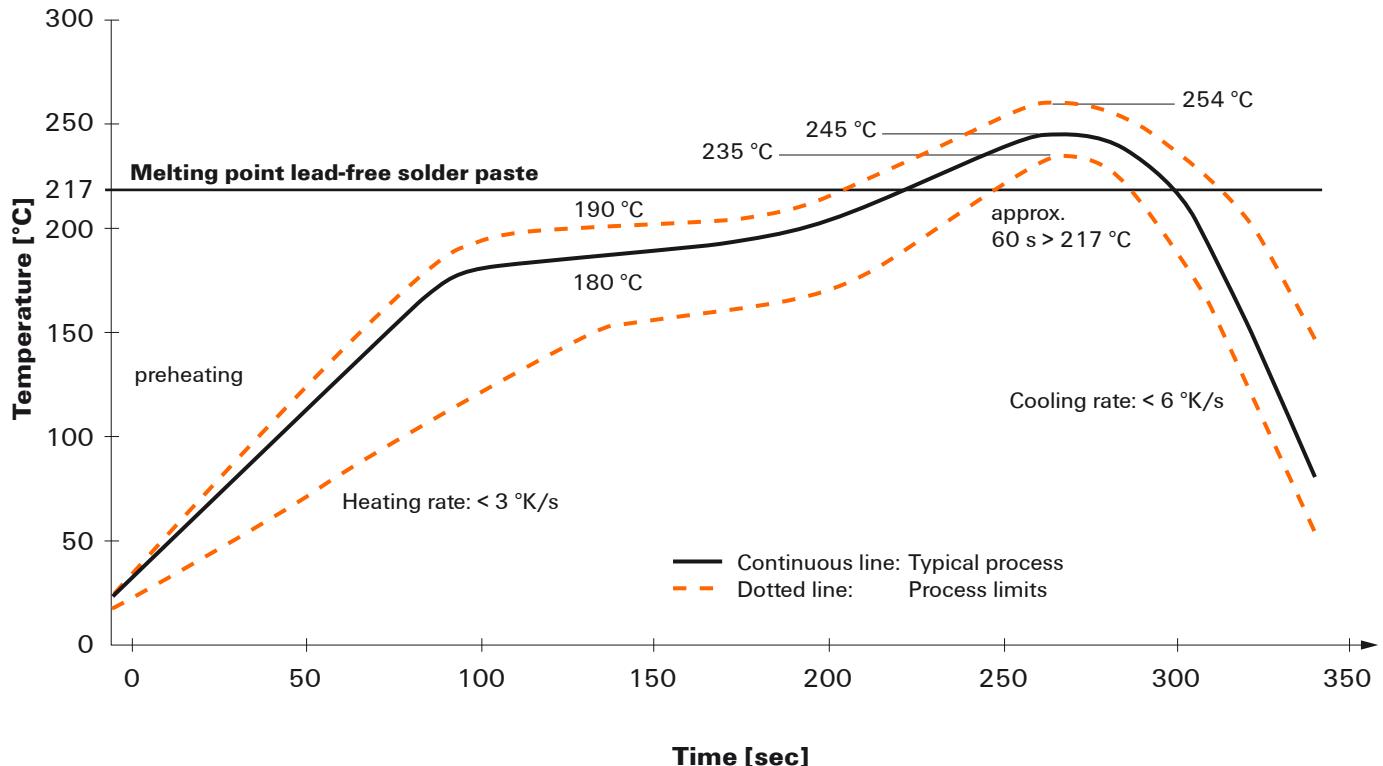
When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

## Recommended reflow soldering profile

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## Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically  $\leq +3\text{K/s}$ . In parallel the solder paste is 'activated'. The time above melting point of  $217^\circ\text{C}$  the paste gets liquid and components and boards begin to connect. The maximum temperature of  $245^\circ\text{C}$  to  $254^\circ\text{C}$  should stay between 10 and 40 seconds. In the cooling phase at  $\geq -6\text{K/s}$  solder is cured. Board and components cool down while avoiding cold cracks.